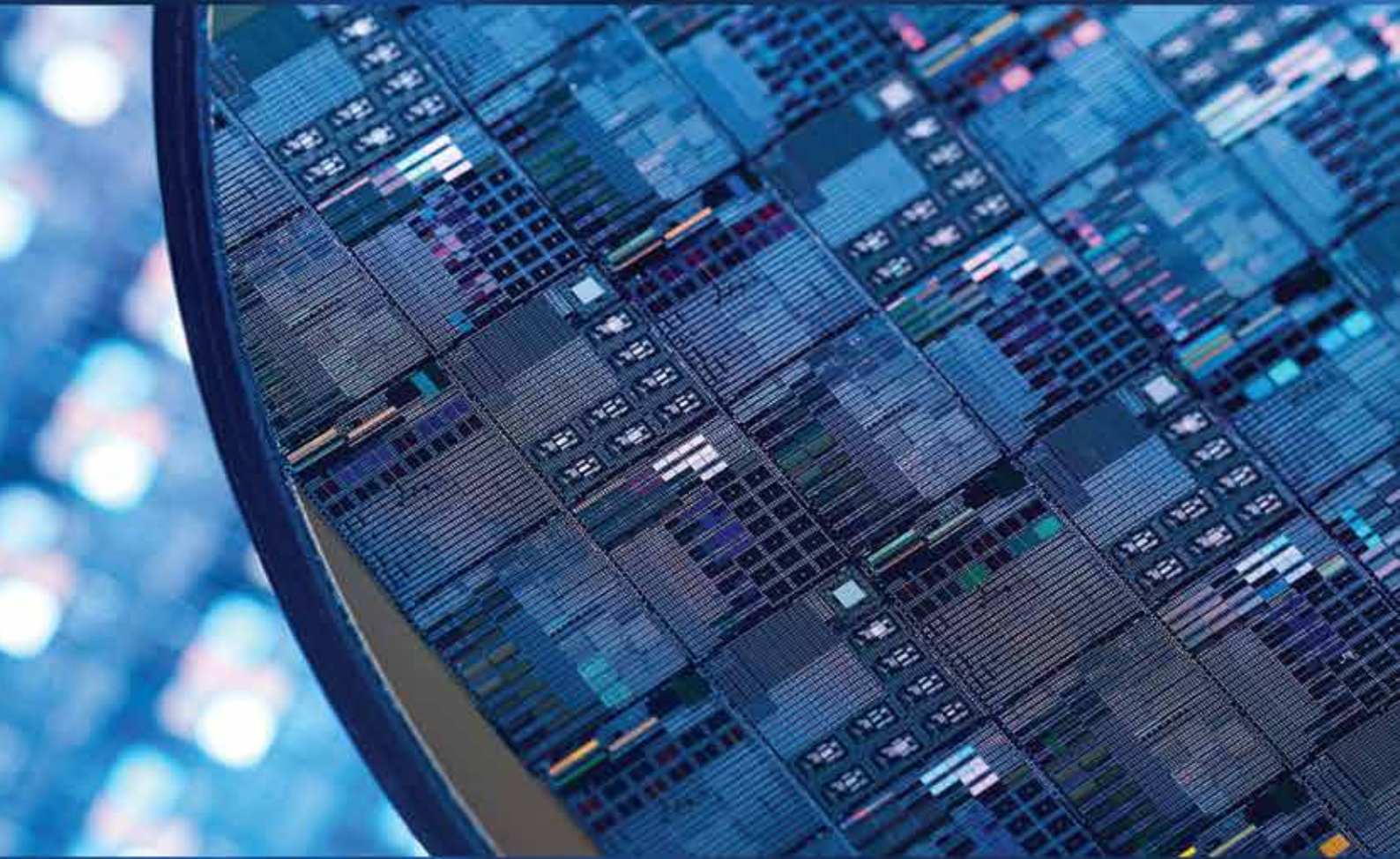




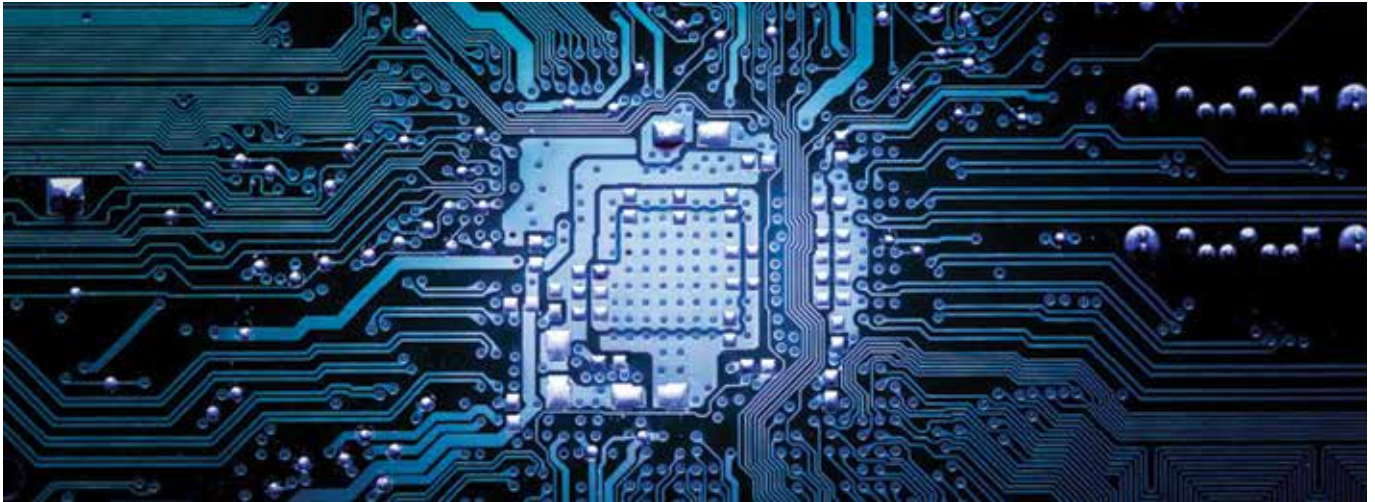
Semiconductor Backend Tools Catalog



2022



AT A GLANCE



Oricus Semicon Solutions is an innovative Semiconductor Tools manufacturing company who, with almost 100 years of collective expertise, craft high tech bespoke tooling solutions for the global Semiconductor Assembly and Test industry.

From one-off customised products to large scale production, our R&D strength, precision manufacturing experience and problem-solving capabilities are impeccable. With a passion for engineering and customer oriented service, we deliver price competitive precision Semiconductor Tooling solutions to a global market with a local presence.

Oricus is made up of a global network of professionals with strong commitment and passion for our work. The company is managed and operated with a spirit of professionalism based on the foundation of integrity, equality and respect. We are determined, objective with a sense of ownership to deliver on our goals. We value our values, professionalism, passion, perseverance and our relentless pursuit to deliver value for our customers.



Authenticity



Expertise



Professionalism



Perseverance



Passion



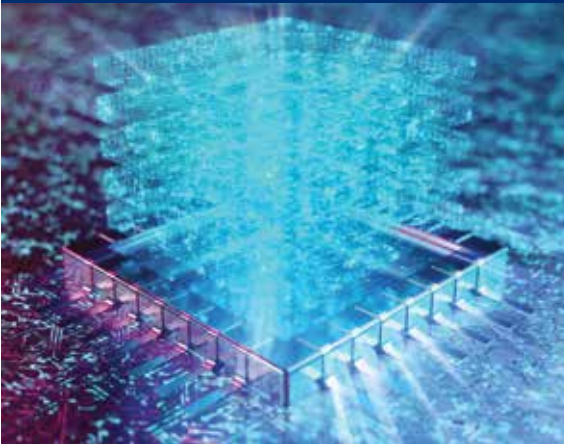
Community

Oriented to Customer's needs



We excel at creating specials – one of a kind pieces, with one of a kind craftsmanship combining with the latest in manufacturing technology to produce micro precision tooling. Oricus can Design and Manufacture either one-offs or high volume orders to your unique specifications, from High Temperature resistant tools for Power Devices to tools with complex geometries for 3D Advanced Packaging.

Industry Leading Solutions



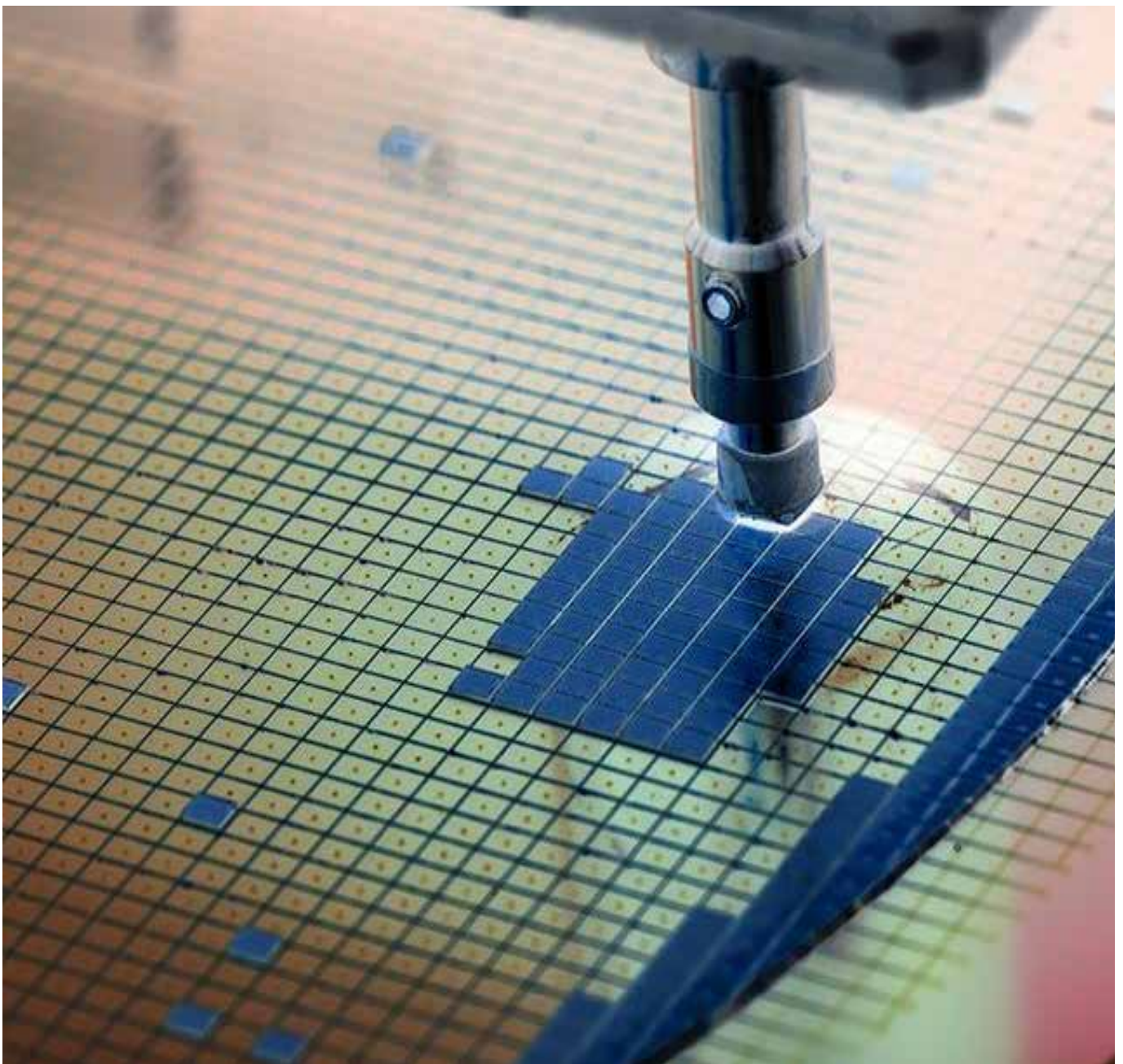
Our Technical Sales Consultants and R&D teams of seasoned Semiconductor Assembly and Test industry professionals will study your chip and package requirements and offer effective and competitive tooling solutions that will work right out of the box. Oricus has the solution to your tooling requirements. Leave it to us and you can focus on your key processes.

Research and Development



R&D is the cornerstone of our commitment to deliver market leading tooling solutions. Our Material Science know-how, coupled with our Manufacturing Expertise and knowledge on the latest demands of Integrated Circuits Packaging allow us to offer tools that maximizes productivity and minimizes downtime.

Die Attach



Pick-Up Tools



Engineering Plastics Tools

Polymeric tips made from POM, PI, PAI and PEI compounds. Economical, replaceable and lightweight, with mid resistance to temperature and wear.



Non Ferrous Tools

Non-Ferrous tools provide excellent thermal transfer and even heat distribution across the tip area with optimized levels of hardness and toughness.



Alloy / Special Alloy Tools

Tools made from Superalloys, Stainless Steel and Tool Steels. For applications that require high resistance of bond force, temperature and wear.



Hybrid Tools

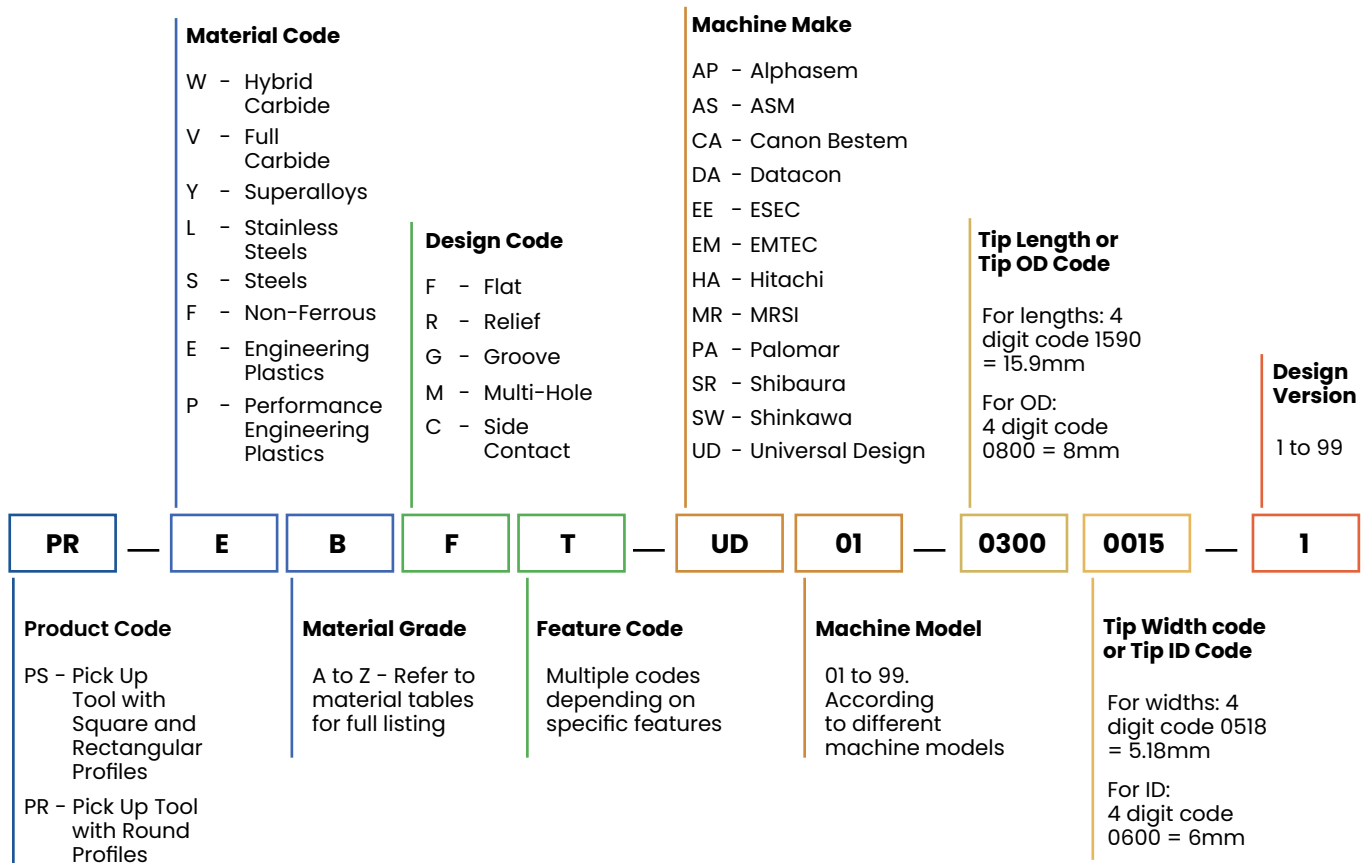
Hybrids offer the performance of Tungsten Carbide while delivering the cost effectiveness of Alloy Tools. Delivers superior Cost to Performance advantages.



Carbide Tools

Toughest tools in our product lineup for the most demanding applications with the highest requirements of strength, temperature and wear resistance.

Part Numbers And Ordering



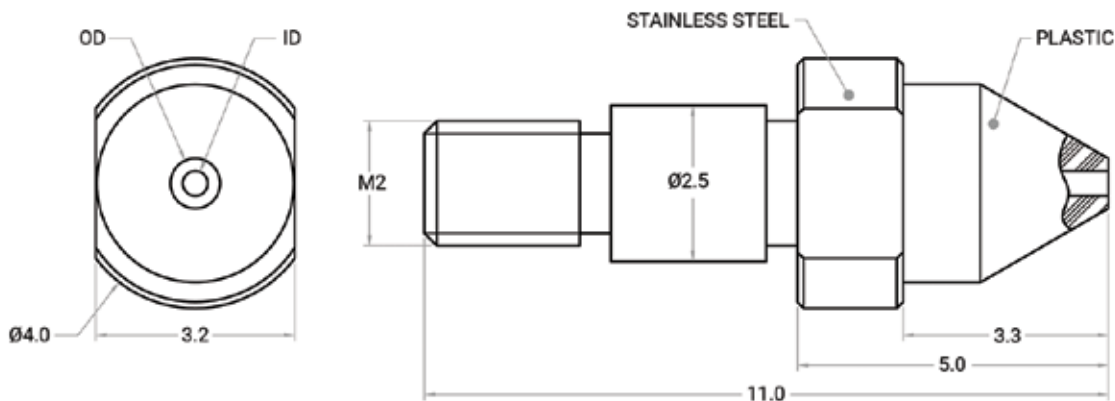
Engineering Plastics Tools



Flat Tip Design

Engineering Plastics Flat Tips are a versatile design that are suitable for a wide range of applications. Flat Tip designs feature a single vacuum hole and a flat contact surface controlled to stringent flatness tolerances.

Oricus manufactures an extensive range of Engineering Plastic Flat Tips sizes with central and offset vacuum hole configurations in various sizes.



Features

- Direct contact to the face of the die or device
- Can be made in Round, Square, Rectangular, and Custom outer profiles
- Certain Engineering Plastics possess E6-E9 Static Dissipative properties to ensure proper Electrostatic Discharge
- Harder than Rubber and softer than Steel/Carbide Flat Tips
- Higher wear resistance as compared to Rubber and lower wear resistance as compared to Steel/Carbide Flat Tips
- Higher temperature resistance as compared to Rubber and lower temperature resistance as compared to Steel/Carbide Flat Tips

Benefits

- Cost effective solution compared to other design types
- Universal design that is suitable for a wide range of dies sizes and thicknesses
- Offers structural support to the die or device, allowing for minimal flex to during the Pick and Place process
- Allows for uniform bond force to be applied throughout the tip surface, reducing the probability of voids in the epoxy or DAF
- Engineering Plastic Flat Tips are more forgiving when less than optimal bond force is applied and will be less likely to damage the die or die surface as compared to Steel or Carbide Flat Tips

Part Number	OD (mm)	ID (mm)
PR-EBFT-UD01-00250015-01	0.25	0.13
PR-EBFT-UD01-00300015-01	0.30	0.15
PR-EBFT-UD01-00350018-01	0.35	0.18
PR-EBFT-UD01-00380018-01	0.38	0.18
PR-EBFT-UD01-00400020-01	0.40	0.20
PR-EBFT-UD01-00450025-01	0.45	0.25
PR-EBFT-UD01-00500030-01	0.50	0.30
PR-EBFT-UD01-00550035-01	0.55	0.35
PR-EBFT-UD01-00600040-01	0.60	0.40
PR-EBFT-UD01-00650045-01	0.65	0.45
PR-EBFT-UD01-00700030-01	0.70	0.30
PR-EBFT-UD01-00750055-01	0.75	0.55
PR-EBFT-UD01-00800050-01	0.80	0.50
PR-EBFT-UD01-00850055-01	0.85	0.55
PR-EBFT-UD01-00900060-01	0.90	0.60
PR-EBFT-UD01-00950065-01	0.95	0.65
PR-EBFT-UD01-01000060-01	1.00	0.60
PR-EBFT-UD01-01150075-01	1.15	0.75
PR-EBFT-UD01-01200060-01	1.20	0.60
PR-EBFT-UD01-01250070-01	1.25	0.70

ESD Properties

Static Dissipative $\geq 10^5$ to $10^9 \Omega$
 Insulative $\geq 10^9 \Omega$

Applications

Standard Die Attach
 Flip Chip
 2.5D/3D
 Wafer Level Packaging
 Panel Level Packaging
 System in a Package

Tip Material

Polycarbonate
 Delrin/POM
 PEEK
 Torlon
 Vespel
 Semitron

Outer Profiles

Round
 Square
 Rectangular
 Custom

Body Shank Material

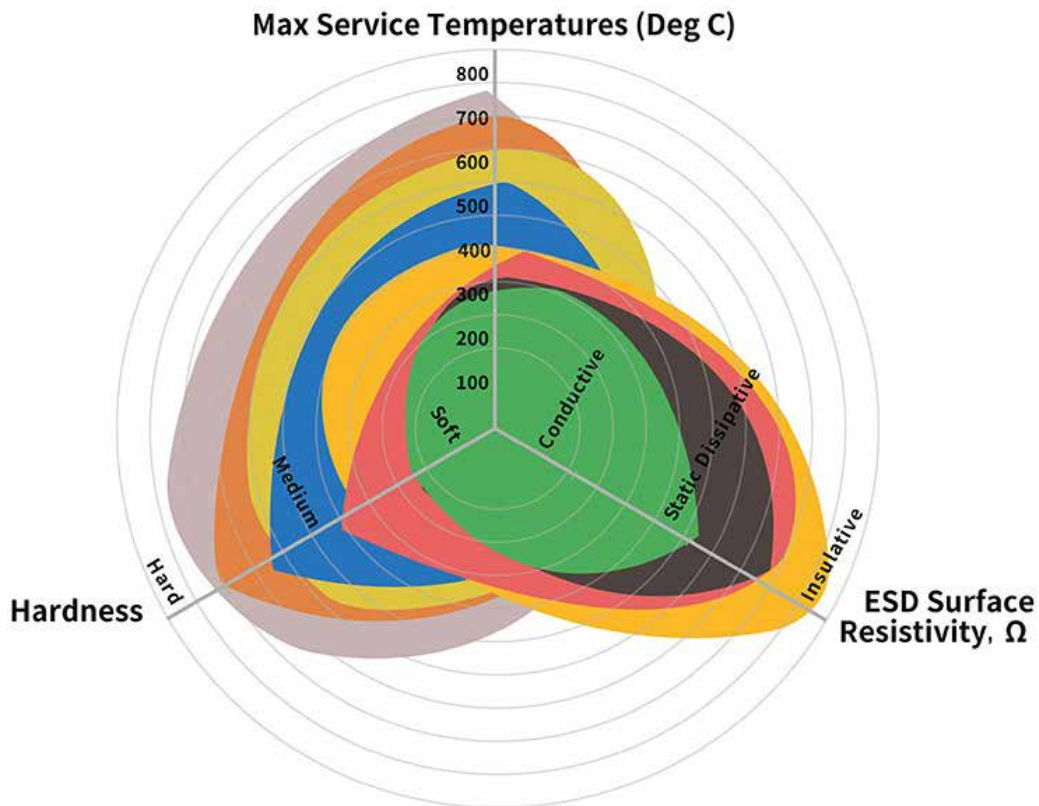
Steel
 Stainless Steel



MATERIALS

Oricus's extensive line of engineered materials specially developed and selected to offer optimal tooling performance for your specific Semiconductor Backend process. Our in-house materials are closely developed in partnership with Original Equipment Manufacturers with input from our customers. For externally procured materials, each material goes through a rigorous Quality Assurance and Performance Assessment programme before making it into our material list.

Oricus' in depth understanding and experience of materials allows us to formulate tooling solutions that work for you. As part of our value proposition, we study the conditions of your application and suggest the most appropriate material that meets your needs.



 Tungsten Carbide *WC Line*

 Superalloy *SA Line*

 Stainless Steel *SS Line*

 Tool Steel *TS Line*

 Non Ferrous Metals *NF Line*

 Performance Engineering Plastics *SP Line*

 Engineering Plastics *EP Line*

 Rubber *R Line*

<p>WC LINE</p> <p>Tungsten Carbide</p> <p>High Wear & High Temp Resistance</p> <p>Carbide, K15 Carbide, K30 Carbide, M30 Carbide K40 Carbide, MG30</p>	<p>SA LINE</p> <p>Superalloy</p> <p>All-Round Superior Performance</p> <p>Haynes 25 (L605) Inconel Alloy 625 Inconel Alloy 718 Incoloy Alloy 925 Nitronic 50 Nitronic 60 Titanium Grade 2 Stellite 6 Stellite 31</p>	<p>SS LINE</p> <p>Stainless Steel</p> <p>Balanced Properties</p> <p>15-5 PH 17-4PH SUS 430F SUS 420 SUS 440C SUS 316 SUS 301 SUS 304 SUS 303</p>	<p>TS LINE</p> <p>Tool Steel</p> <p>High Strength</p> <p>CPM-10V SKD 11 SKH 51 Mirrax 40 ASP 23 Stavax XW 10 XW 42 Assab 718 - HH HSS DF2 DF3 Ramax HH Rochling 2315</p>
<p>NF LINE</p> <p>Non Ferrous Metals</p> <p>Special Applications</p> <p>Aluminium 7075 Aluminium 6061 Copper Brass Hovadur K350</p>	<p>SP LINE</p> <p>Performance Engineering Plastics</p> <p>Advantageous Performance & Value</p> <p>Torlon 4432 (PAI) Torlon 4301 (PAI) Torlon 5030 (PAI) Toriion 7130 (PAI) Vespel SCP5050 (P) Vespel SP 21 (PD) Vespel SP1 (PI) ESD Semitron 520 ESD Semitron 420 ESD Semitron 410C ESD Semitron 225</p>	<p>EP LINE</p> <p>Engineering Plastics</p> <p>Economical And Versatile</p> <p>Acrylic/ Polycarbonate TECAFORM SD Delrin ESD Delrin White Delrin Black POM PEEK PEEK HT PEEK GF 30% PEEK CF 30%</p>	<p>R LINE</p> <p>Rubber</p> <p>Geometric Flexibility ESD Protection</p> <p>NBR NBR (Soft) NBR (Hard) NBR (Coated) HPR HPR (Soft) HPR (Hard) UPR CR (ESD) CR</p>

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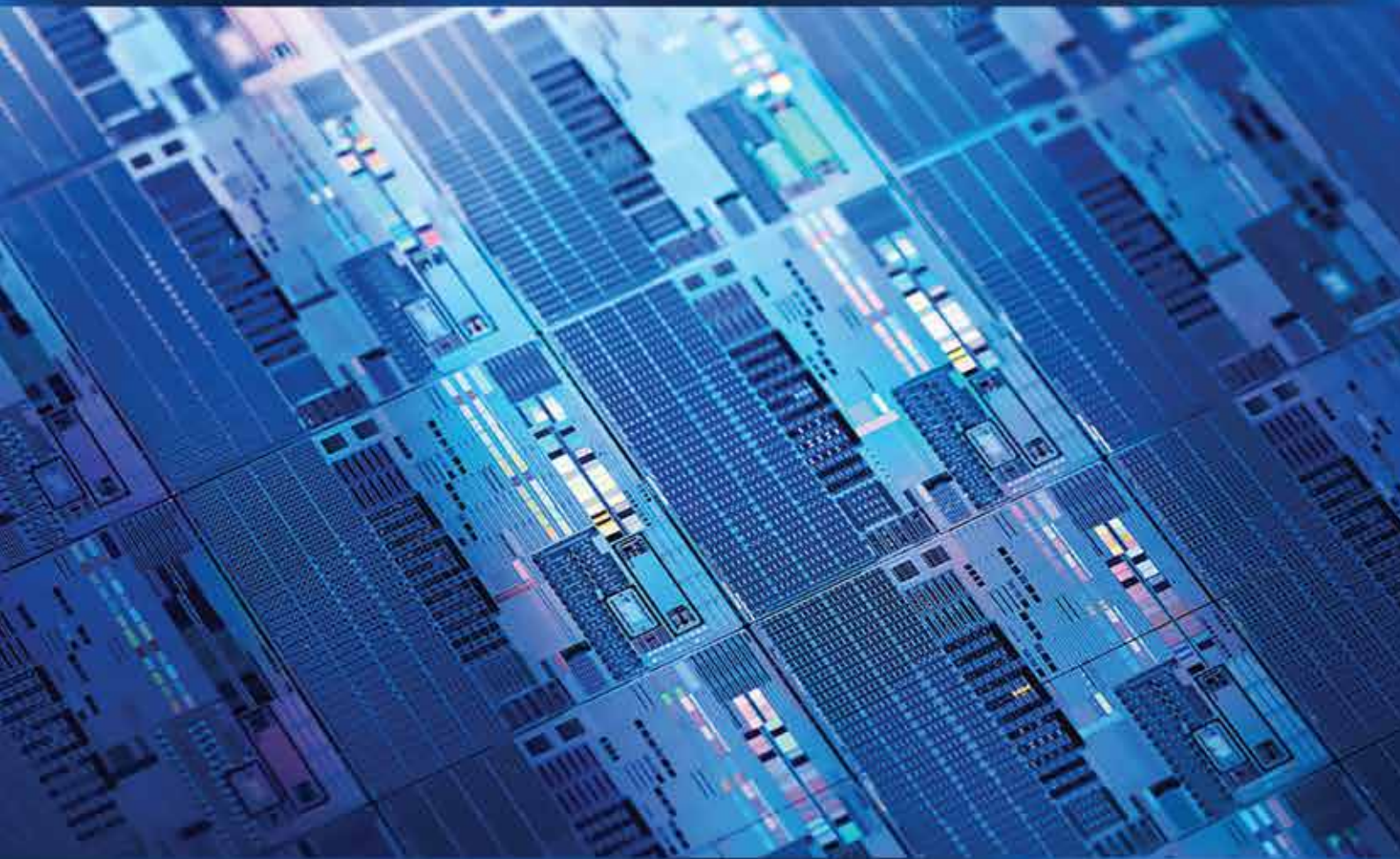
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